1200V, 85A, $V_{ce(on)}$ = 2.5V Typical

Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT® is a new generation of high voltage power IGBTs. Using Non-Punch-Through Technology, the Ultra Fast NPT-IGBT® offers superior ruggedness and ultrafast switching speed.

Features

- · Low Saturation Voltage
- Low Tail Current
- RoHS Compliant

- · Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current



Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power



MAXIMIM RATINGS

supplies (UPS).

MAXIMUN	I RATINGS All Ratings: T	$_{\rm C}$ = 25°C unless otherwise s	25°C unless otherwise specified.		
Symbol	Parameter	Ratings	Unit		
V _{ces}	Collector Emitter Voltage	1200	V		
$V_{\rm GE}$	Gate-Emitter Voltage	±30			
I _{C1}	Continuous Collector Current @ T _c = 25°C	118			
I _{C2}	Continuous Collector Current @ T _c = 75°C	85	Α		
I _{CM}	Pulsed Collector Current ①	340			
SCWT	Short Circuit Withstand Time: V _{CE} = 600V, V _{GE} = 15V, T _C =125°C	10	μs		
$P_{\scriptscriptstyle D}$	Total Power Dissipation @ T _c = 25°C	595	W		
T _J ,T _{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C		
T _L	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300			

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage (V _{GE} = 0V, I _C = 1.0mA)	1200			
$V_{\text{GE(TH)}}$	Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 2.5 \text{mA}, T_{j} = 25 ^{\circ}\text{C})$	3.5	5.0	6.5	Volts
V _{CE(ON)}	Collector-Emitter On Voltage $(V_{GE} = 15V, I_{C} = 85A, T_{j} = 25^{\circ}C)$		2.5	3.2	
	Collector-Emitter On Voltage (V _{GE} = 15V, I _C = 85A, T _j = 125°C)		3.3		
	Collector-Emitter On Voltage $(V_{GE} = 15V, I_{C} = 170A, T_{j} = 25^{\circ}C)$		3.5		
I _{CES}	Collector Cut-off Current $(V_{CE} = 1200V, V_{GE} = 0V, T_{j} = 25^{\circ}C)$		10	1000	μA
	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 125°C) (2)		100		
I _{GES}	Gate-Emitter Leakage Current (V _{GE} = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

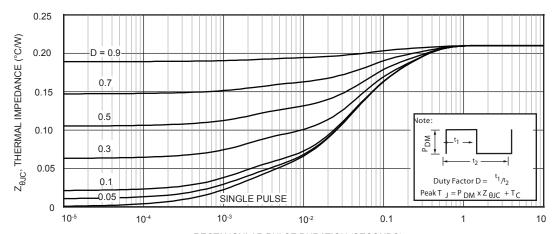
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C _{ies}	Input Capacitance	Capacitance		8400		
C _{oes}	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		725		pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz		190		
V_{GEP}	Gate to Emitter Plateau Voltage	Cata Charra		7.5		V
Q3	Total Gate Charge	Gate Charge		490	660	
Q_ge	Gate-Emitter Charge	V _{GE} = 15V		60	85	
Q_{gc}	Gate- Collector Charge	$V_{CE} = 600V$ $I_{C} = 85A$		230	320	nC
t _{d(on)}	Turn-On Delay Time	Inductive Switching (25°C)		43		
t,	Current Rise Time	V _{CC} = 600V		70		20
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		300		ns
t _f	Current Fall Time	I _C = 85A		85		
E _{on2} ⑤	Turn-On Switching Energy	$R_{G} = 4.3 \Omega^{(4)}$		6000	9000	1
E _{off}	Turn-Off Switching Energy	T _J = +25°C		3800	5700	μJ
t _{d(on)}	Turn-On Delay Time	Inductive Switching (125°C)		43		
t _r	Current Rise Time	V _{CC} = 600V		70		20
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		350		ns
t _f	Current Fall Time	I _C = 85A		95		
E _{on2} 5	Turn-On Switching Energy	$R_{G} = 4.3 \ \Omega^{(4)}$		7800	11,700	1
E _{off}	Turn-Off Switching Energy	T _J = +125°C		4900	7350	μJ

THERMAL AND MECHANICAL CHARACTERISTICS

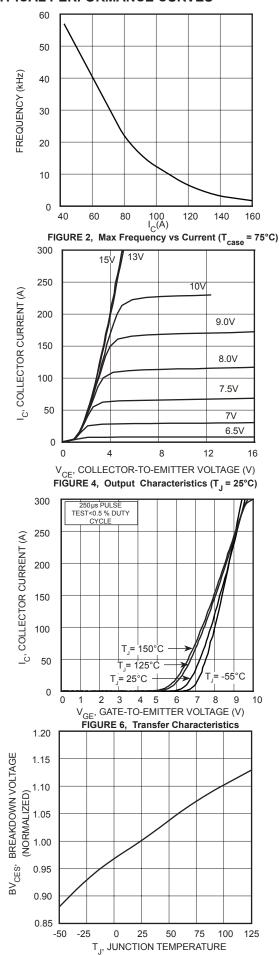
Symbol	Characteristic / Test Conditions	Min	Тур	Max	Unit
$R_{_{\theta JC}}$	Junction to Case	-	-	0.21	°C/W
W _T	Package Weight	-	1.03	-	OZ
Torque	Terminals and Mounting Screws.	-	-	10	in∙lbf
		-	-	1.1	N·m
V	RMS Voltage (50-60Hz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.)	2500	-	-	Volts

- 1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.
- 2 Pulse test: Pulse Width < $380\mu s$, duty cycle < 2%.
- 3 See Mil-Std-750 Method 3471.
- $4~~R_{_{
 m G}}$ is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)
- 5 $\,$ E $_{\mbox{\tiny on2}}$ is the energy loss at turn-on and includes the charge stored in the freewheeling diode.
- 6 E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.



RECTANGULAR PULSE DURATION (SECONDS)
Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration



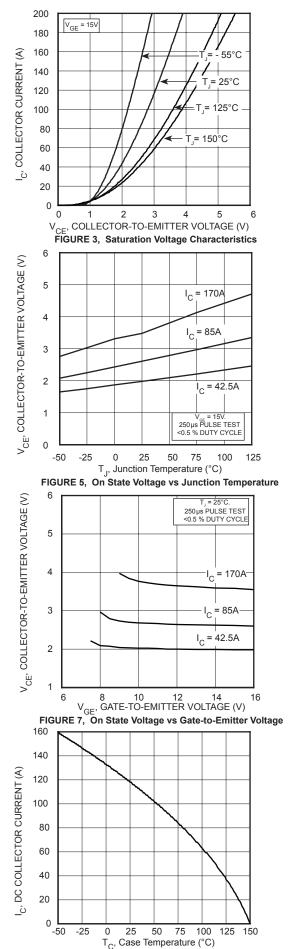
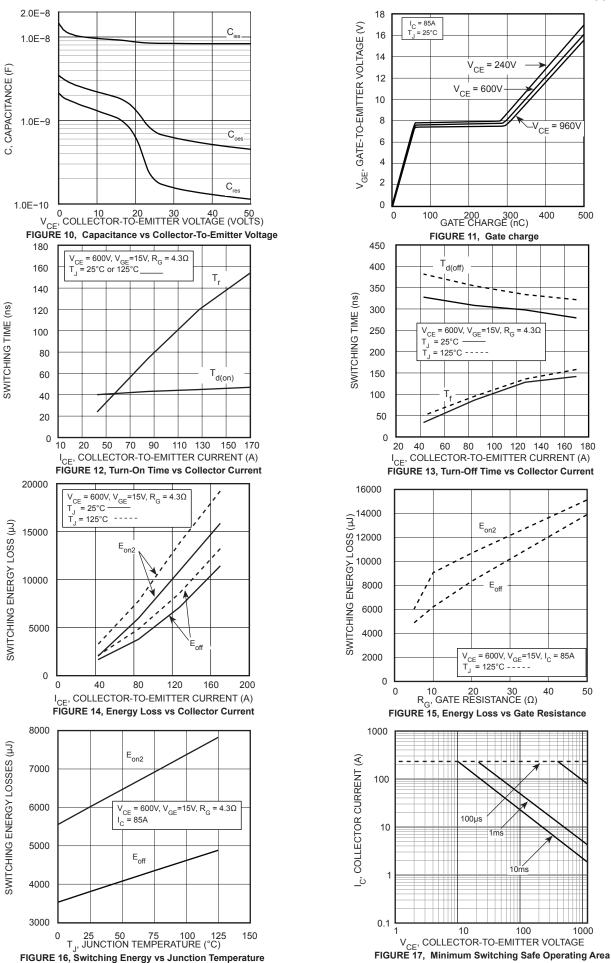


FIGURE 9, DC Collector Current vs Case Temperature

FIGURE 8, Breakdown Voltage vs Junction Temperature

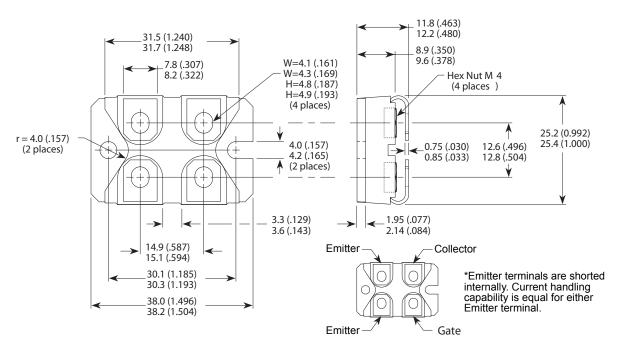


3-2013

Rev B

052-6403

SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

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